

74HC4520-Q100; 74HCT4520-Q100

Dual 4-bit synchronous binary counter

Rev. 4 — 2 April 2024

Product data sheet

1. General description

The 74HC4520-Q100; 74HCT4520-Q100 are dual 4-bit internally synchronous binary counters with two clock inputs ($nCP0$ and $n\overline{CP}1$). They have buffered outputs from all 4 bit positions ($nQ0$ to $nQ3$), and an asynchronous master reset input (nMR). The counter advances on either the LOW-to-HIGH transition of $nCP0$ when $n\overline{CP}1$ is HIGH. It also advances on the HIGH-to-LOW transition of $n\overline{CP}1$ if $nCP0$ is LOW. Either $nCP0$ or $n\overline{CP}1$ may be used as the clock input to the counter. The other clock input may be used as a clock enable input. A HIGH on nMR resets the counter ($nQ0$ to $nQ3$ = LOW) independent of $nCP0$ and $n\overline{CP}1$. Inputs include clamp diodes. It enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 2.0 V to 6.0 V
- CMOS low power dissipation
- High noise immunity
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Complies with JEDEC standards:
 - JESD8C (2.7 V to 3.6 V)
 - JESD7A (2.0 V to 6.0 V)
- Input levels:
 - For 74HC4520-Q100: CMOS level
 - For 74HCT4520-Q100: TTL level
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V

3. Applications

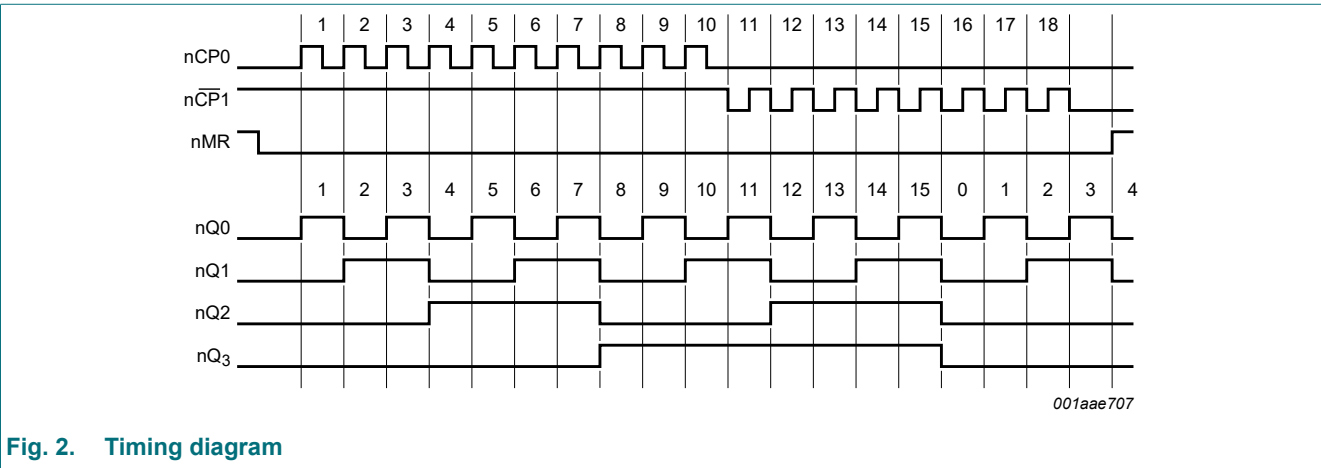
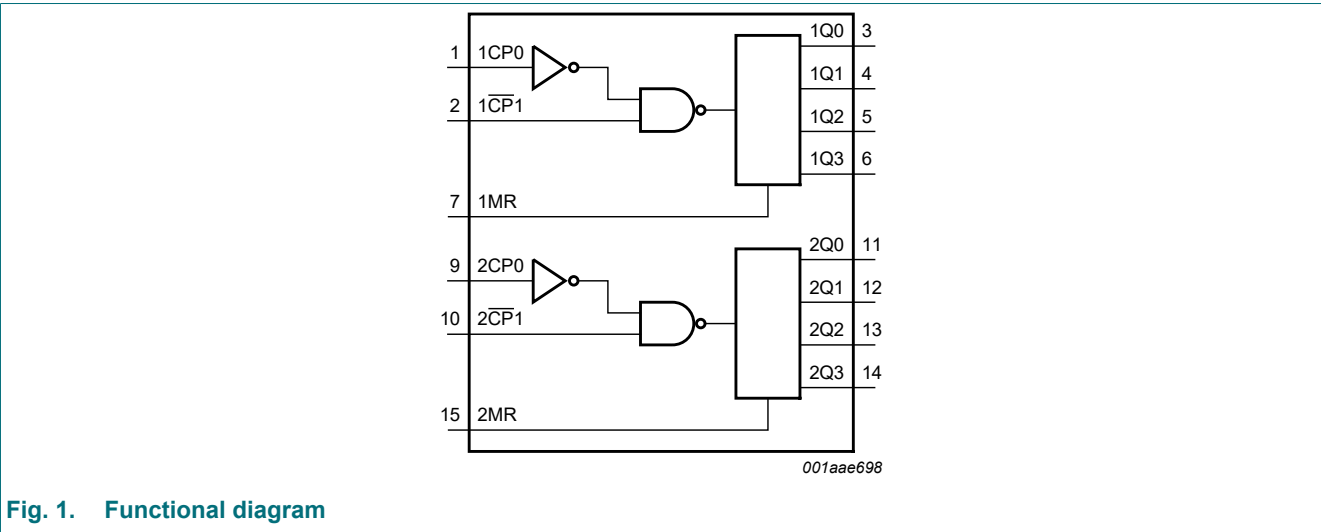
- Multistage synchronous counting
- Multistage asynchronous counting
- Frequency dividers

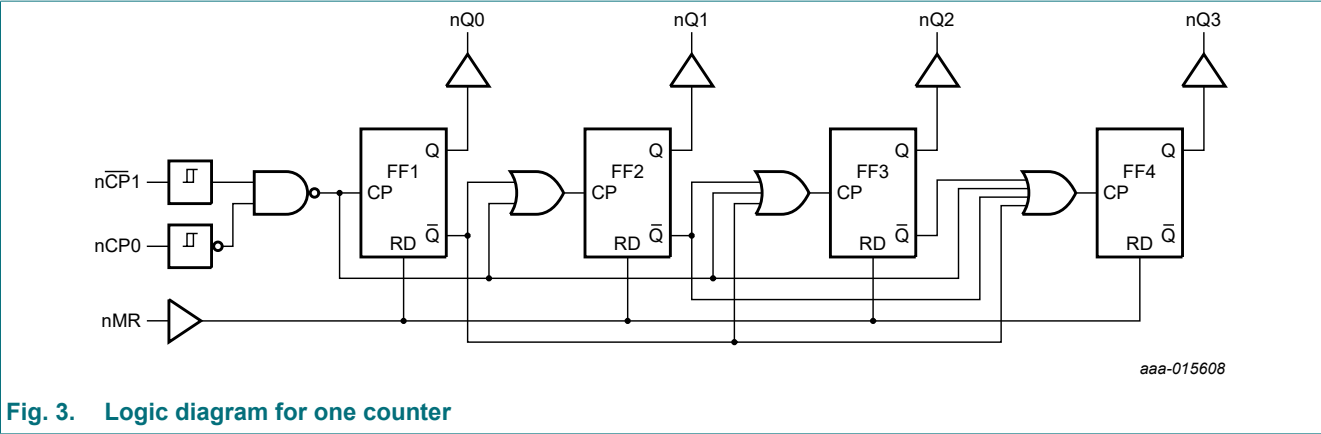
4. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74HC4520D-Q100	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
74HCT4520D-Q100				
74HC4520PW-Q100	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1

5. Functional diagram





6. Pinning information

6.1. Pinning

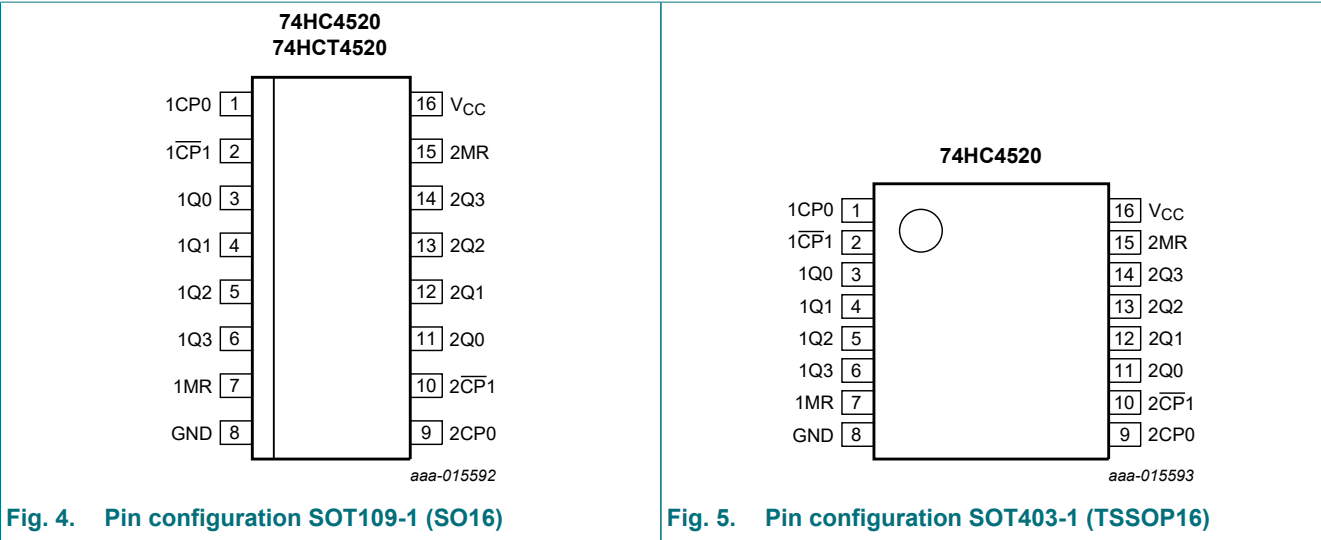


Fig. 4. Pin configuration SOT109-1 (SO16)

Fig. 5. Pin configuration SOT403-1 (TSSOP16)

6.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1CP0, 2CP0	1, 9	clock input (LOW-to-HIGH edge-triggered)
1CP1, 2CP1	2, 10	clock input (HIGH-to-LOW edge-triggered)
1Q0 to 1Q3	3, 4, 5, 6	output
1MR, 2MR	7, 15	asynchronous master reset input (active HIGH)
GND	8	ground (0 V)
2Q0 to 2Q3	11, 12, 13, 14	output
V _{CC}	16	supply voltage

7. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; ↑ = positive-going transition; ↓ = negative-going transition.

nCP0	nCP1	nMR	Mode
↑	H	L	counter advances
L	↓	L	counter advances
↓	X	L	no change
X	↑	L	no change
↑	L	L	no change
H	↓	L	no change
X	X	H	nQ0 to nQ3 = LOW

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7.0	V
I _{IK}	input clamping current	V _I < -0.5 V or V _I > V _{CC} + 0.5 V	-	±20	mA
I _{OK}	output clamping current	V _O < -0.5 V or V _O > V _{CC} + 0.5 V	-	±20	mA
I _O	output current	V _O = -0.5 V to V _{CC} + 0.5 V	-	±25	mA
I _{CC}	supply current		-	50	mA
I _{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	[1]	-	500	mW

[1] For SOT109-1 (SO16) package: P_{tot} derates linearly with 12.4 mW/K above 110 °C.
For SOT403-1 (TSSOP16) package: P_{tot} derates linearly with 8.5 mW/K above 91 °C.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC4520-Q100			74HCT4520-Q100			Unit
			Min	Typ	Max	Min	Typ	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
V _I	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
V _O	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 2.0 V	-	-	625	-	-	-	ns/V
		V _{CC} = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V _{CC} = 6.0 V	-	-	83	-	-	-	ns/V

10. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
74HC4520-Q100										
V _{IH}	HIGH-level input voltage	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
		V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
		V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V _{OH}	HIGH-level output voltage	V _I = V _{IH} or V _{IL}								
		I _O = -20 µA; V _{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I _O = -20 µA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -20 µA; V _{CC} = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I _O = -4.0; V _{CC} = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		I _O = -5.2; V _{CC} = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL}								
		I _O = 20 µA; V _{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 µA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 µA; V _{CC} = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA; V _{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I _O = 5.2 mA; V _{CC} = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
I _I	input leakage current	V _I = V _{CC} or GND; V _{CC} = 6.0 V	-	-	±0.1	-	±1.0	-	±1.0	µA
I _{CC}	supply current	V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 6.0 V	-	-	8.0	-	80.0	-	160.0	µA
C _I	input capacitance		-	3.5	-	-	-	-	-	pF
74HCT4520-Q100										
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level output voltage	V _I = V _{IH} or V _{IL} ; V _{CC} = 4.5 V								
		I _O = -20 µA	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -4.0 mA	3.98	4.32	-	3.84	-	3.7	-	V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL} ; V _{CC} = 4.5 V								
		I _O = 20 µA	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA	-	0.15	0.26	-	0.33	-	0.4	V

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
I _I	input leakage current	V _I = V _{CC} or GND; V _{CC} = 5.5 V	-	-	±0.1	-	±1.0	-	±1.0	µA
I _{CC}	supply current	V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V	-	-	8.0	-	80.0	-	160.0	µA
ΔI _{CC}	additional supply current	per input pin; V _I = V _{CC} - 2.1 V; other inputs at V _{CC} or GND; V _{CC} = 4.5 V to 5.5 V; I _O = 0 A								
		pin nCP0, nCP1	-	80	288	-	360	-	392	µA
		pin nMR	-	150	540	-	675	-	735	µA
C _I	input capacitance		-	3.5	-	-	-	-	-	pF

11. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit, see Fig. 8.

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
74HC4520-Q100										
t _{pd}	propagation delay	nCP0 to nQn; see Fig. 6 [1]								
		V _{CC} = 2.0 V	-	77	240	-	300	-	360	ns
		V _{CC} = 4.5 V	-	28	48	-	60	-	72	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	24	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	22	41	-	51	-	61	ns
		nCP1 to nQn; see Fig. 6 [1]								
		V _{CC} = 2.0 V	-	77	240	-	300	-	360	ns
		V _{CC} = 4.5 V	-	28	48	-	60	-	72	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	24	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	22	41	-	51	-	61	ns
t _{PHL}	HIGH to LOW propagation delay	nMR to nQn; see Fig. 6								
		V _{CC} = 2.0 V	-	44	150	-	190	-	225	ns
		V _{CC} = 4.5 V	-	16	30	-	38	-	45	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	13	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	13	26	-	33	-	38	ns
t _t	transition time	nQn; see Fig. 6 [2]								
		V _{CC} = 2.0 V	-	19	75	-	95	-	110	ns
		V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
		V _{CC} = 6.0 V	-	6	13	-	16	-	19	ns

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
t_W	pulse width	nCP0, nCP1 HIGH or LOW; see Fig. 7								
		$V_{CC} = 2.0 \text{ V}$	80	22	-	100	-	120	-	ns
		$V_{CC} = 4.5 \text{ V}$	16	8	-	20	-	24	-	ns
		$V_{CC} = 6.0 \text{ V}$	14	6	-	17	-	20	-	ns
		nMR HIGH; see Fig. 7								
		$V_{CC} = 2.0 \text{ V}$	120	39	-	150	-	180	-	ns
		$V_{CC} = 4.5 \text{ V}$	24	14	-	30	-	36	-	ns
		$V_{CC} = 6.0 \text{ V}$	20	11	-	26	-	31	-	ns
t_{rec}	recovery time	nMR to nCP0, nCP1; see Fig. 7								
		$V_{CC} = 2.0 \text{ V}$	0	-28	-	0	-	0	-	ns
		$V_{CC} = 4.5 \text{ V}$	0	-10	-	0	-	0	-	ns
		$V_{CC} = 6.0 \text{ V}$	0	-8	-	0	-	0	-	ns
t_{su}	set-up time	nCP0 to nCP1; nCP1 to nCP0; see Fig. 6								
		$V_{CC} = 2.0 \text{ V}$	80	14	-	100	-	120	-	ns
		$V_{CC} = 4.5 \text{ V}$	16	5	-	20	-	24	-	ns
		$V_{CC} = 6.0 \text{ V}$	14	4	-	17	-	20	-	ns
f_{max}	maximum frequency	nCP0, nCP1; see Fig. 7								
		$V_{CC} = 2.0 \text{ V}$	6	19	-	4.8	-	4	-	MHz
		$V_{CC} = 4.5 \text{ V}$	30	58	-	24	-	20	-	MHz
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	68	-	-	-	-	-	MHz
		$V_{CC} = 6.0 \text{ V}$	35	69	-	28	-	24	-	MHz
C_{PD}	power dissipation capacitance	$V_I = \text{GND to } V_{CC}; V_{CC} = 5 \text{ V}; f_i = 1 \text{ MHz}$ [3]	-	29	-	-	-	-	-	pF
74HCT4520-Q100										
t_{pd}	propagation delay	nCP0 to nQn; see Fig. 6 [1]								
		$V_{CC} = 4.5 \text{ V}$	-	28	53	-	66	-	80	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	24	-	-	-	-	-	ns
		nCP1 to nQn; see Fig. 6 [1]								
		$V_{CC} = 4.5 \text{ V}$	-	25	53	-	66	-	80	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	24	-	-	-	-	-	ns
t_{PHL}	HIGH to LOW propagation delay	nMR to nQn; see Fig. 6								
		$V_{CC} = 4.5 \text{ V}$	-	16	35	-	44	-	53	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	13	-	-	-	-	-	ns
t_t	transition time	nQn; see Fig. 6 [2]								
		$V_{CC} = 4.5 \text{ V}$	-	7	15	-	19	-	22	ns
t_W	pulse width	nCP0, nCP1 HIGH or LOW; see Fig. 7								
		$V_{CC} = 4.5 \text{ V}$	20	10	-	25	-	30	-	ns
		nMR HIGH; see Fig. 7								
		$V_{CC} = 4.5 \text{ V}$	20	12	-	25	-	30	-	ns

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
t _{rec}	recovery time	nMR to nCP0, nCP1; see Fig. 7								
		V _{CC} = 4.5 V	0	-8	-	0	-	0	-	ns
t _{su}	set-up time	nCP0 to nCP1; nCP1 to nCP0; see Fig. 6								
		V _{CC} = 4.5 V	16	6	-	20	-	24	-	ns
f _{max}	maximum frequency	nCP0, nCP1; see Fig. 7								
		V _{CC} = 4.5 V	30	58	-	24	-	20	-	MHz
		V _{CC} = 5.0 V; C _L = 15 pF	-	64	-	-	-	-	-	MHz
C _{PD}	power dissipation capacitance	V _I = GND to V _{CC} - 1.5 V; V _{CC} = 5 V; [3] f _i = 1 MHz	-	24	-	-	-	-	-	pF

[1] t_{pd} is the same as t_{PHL} and t_{PLH}.

[2] t_i is the same as t_{THL} and t_{TLH}.

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW):
 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where:
f_i = input frequency in MHz;
f_o = output frequency in MHz;
C_L = output load capacitance in pF;
V_{CC} = supply voltage in V;
N = number of inputs switching;
 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

11.1. Waveforms and test circuit

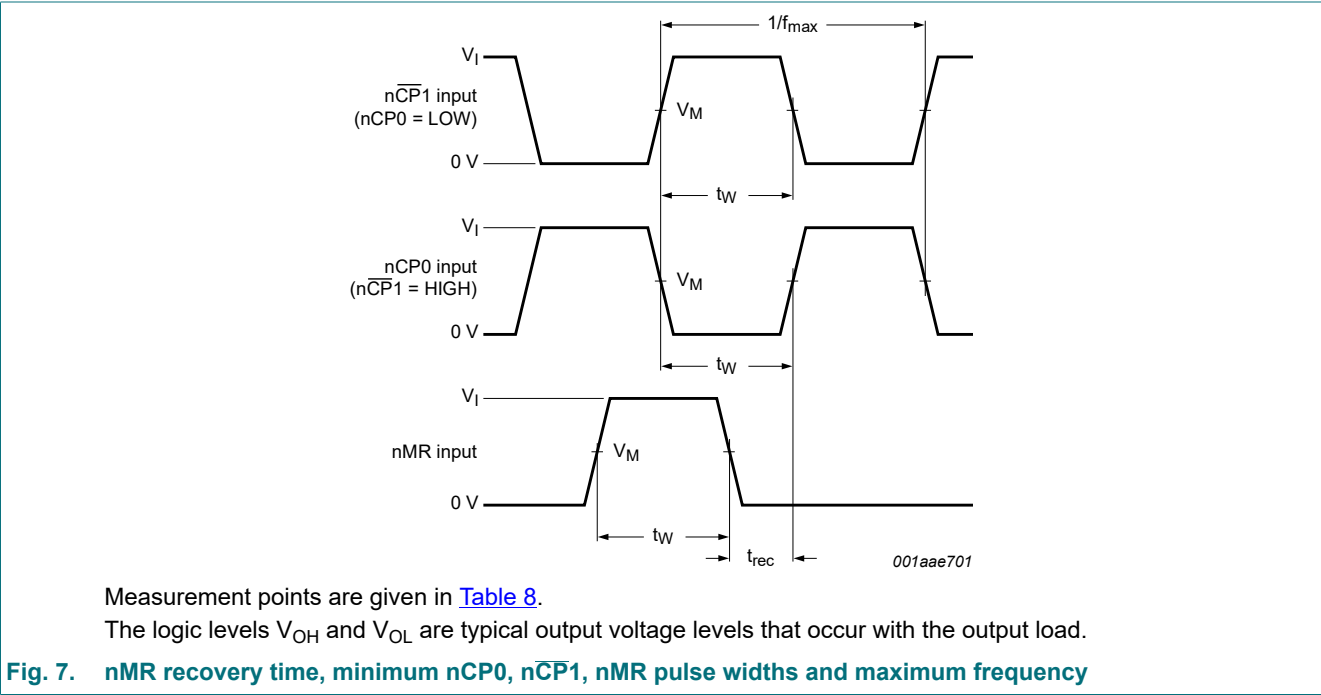
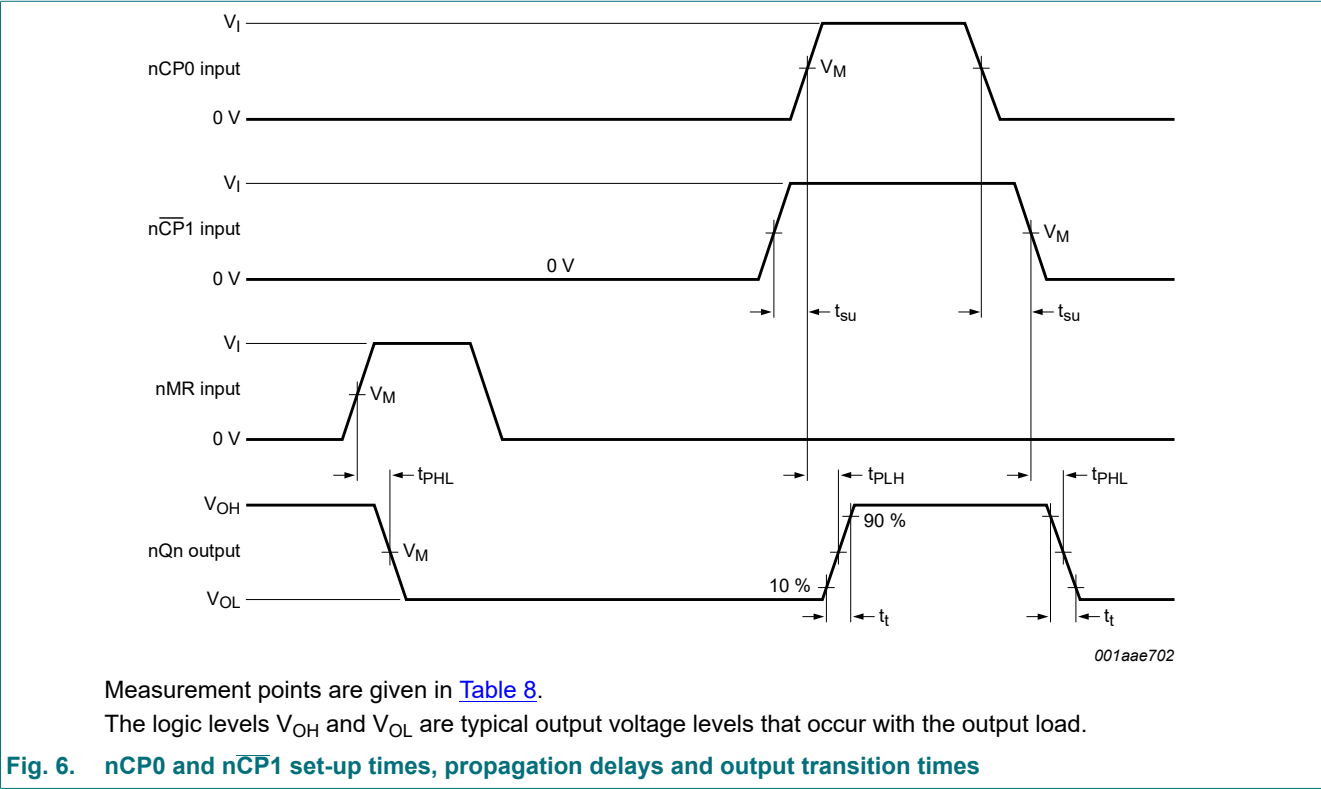


Table 8. Measurement points

Type	Input		Output
	V_M	V_I	V_M
74HC4520-Q100	$0.5 \times V_{CC}$	GND to V_{CC}	$0.5 \times V_{CC}$
74HCT4520-Q100	1.3 V	GND to 3 V	1.3 V

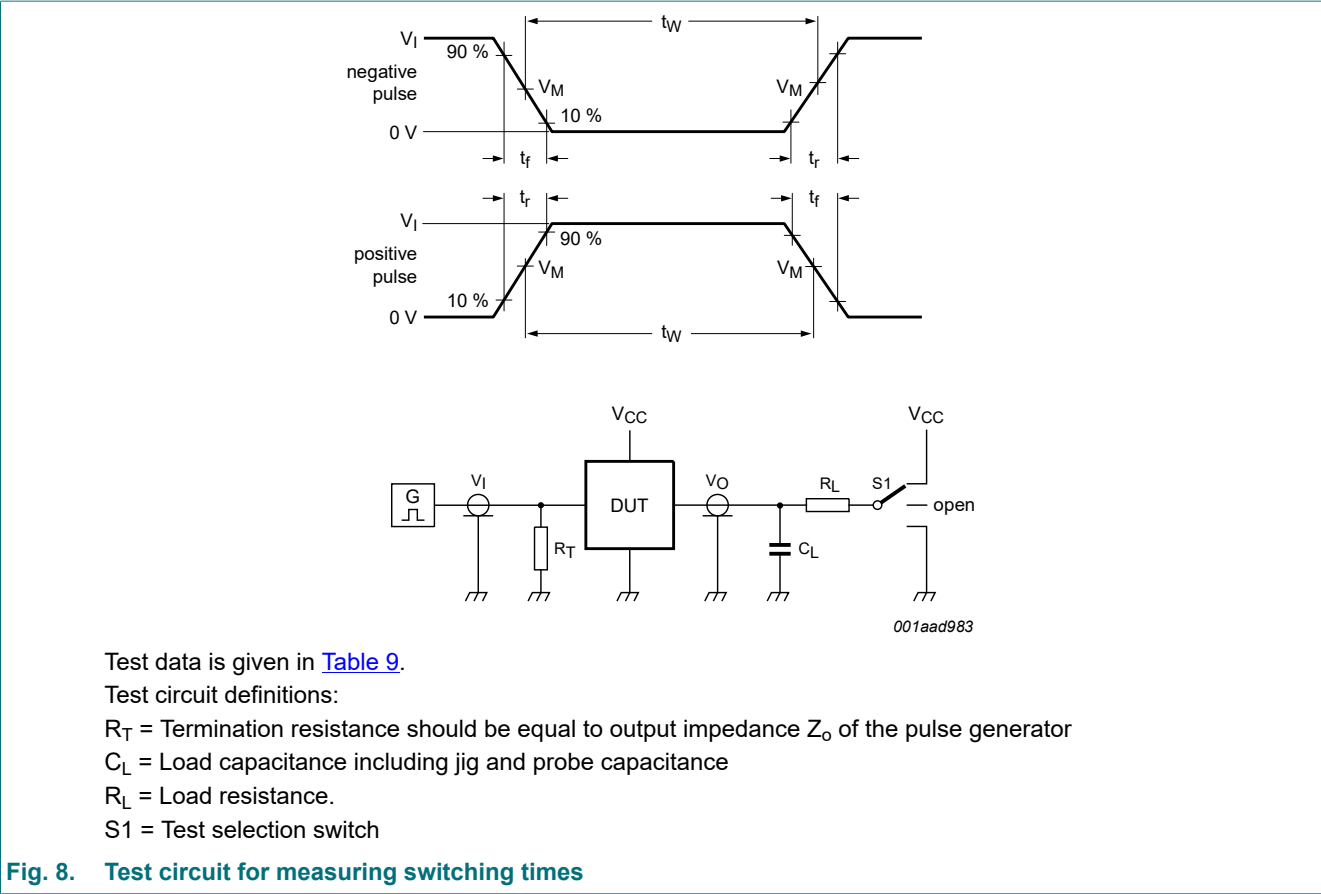


Fig. 8. Test circuit for measuring switching times

Table 9. Test data

Type	Input		Load		S1 position
	V_I	t_r, t_f	C_L	R_L	
74HC4520-Q100	GND to V_{CC}	6 ns	15 pF, 50 pF	1 k Ω	open
74HCT4520-Q100	GND to 3 V	6 ns	15 pF, 50 pF	1 k Ω	open

12. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1

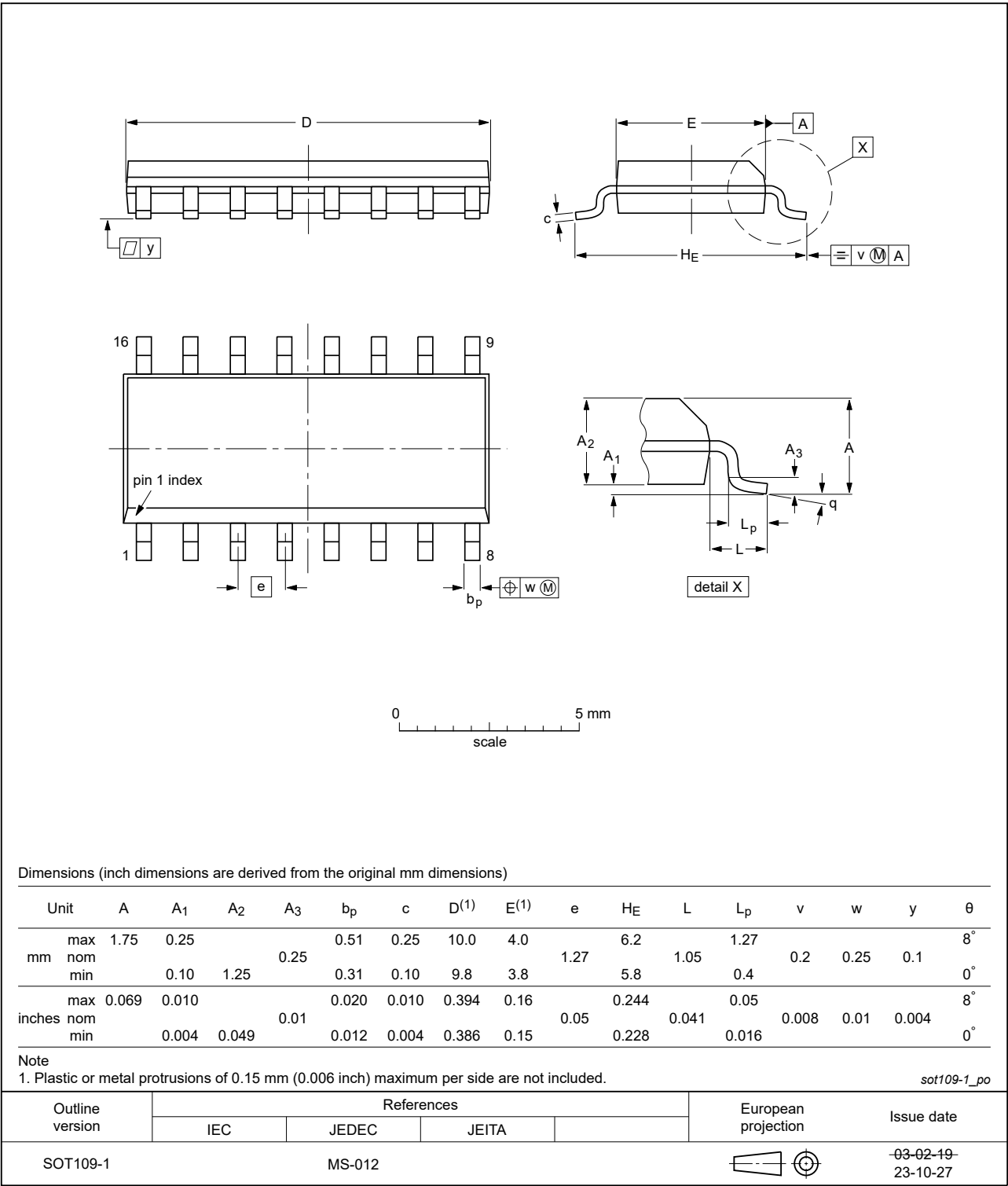


Fig. 9. Package outline SOT109-1 (SO16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1

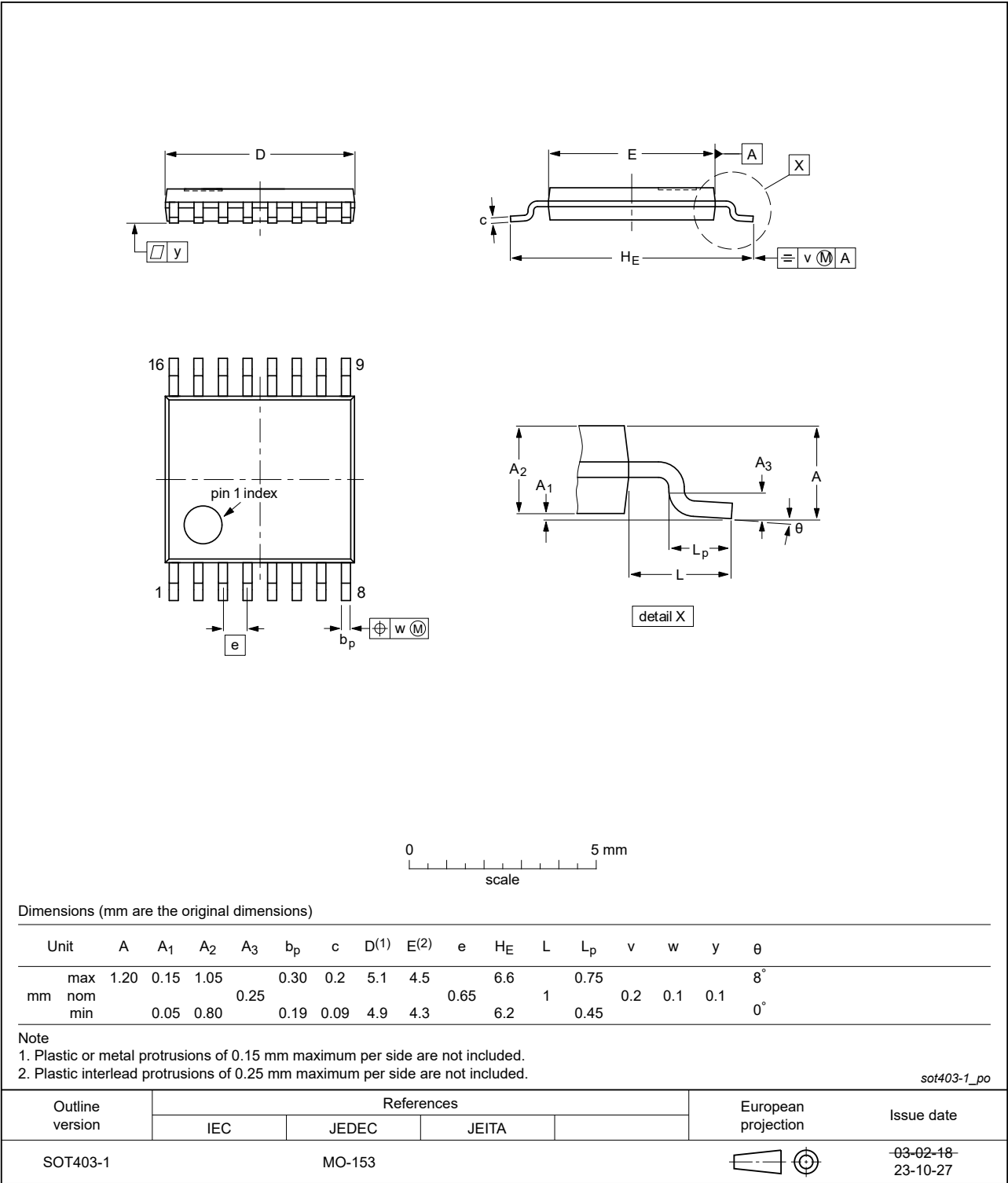


Fig. 10. Package outline SOT403-1 (TSSOP16)

13. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT4520_Q100 v.4	20240402	Product data sheet	-	74HC_HCT4520_Q100 v.3
Modifications:	<ul style="list-style-type: none">Fig. 9, Fig. 10: Aligned SO and TSSOP package outline drawings to JEDEC MS-012 and MO-153.Section 2: ESD specification updated according to the latest JEDEC standard.			
74HC_HCT4520_Q100 v.3	20201009	Product data sheet	-	74HC_HCT4520_Q100 v.2
Modifications:	<ul style="list-style-type: none">Type number 74HC4520PW-Q100 (SOT403-1/TSSOP16) added.Section 2 updated.Table 4: Derating values for P_{tot} total power dissipation have been updated.			
74HC_HCT4520_Q100 v.2	20190214	Product data sheet	-	74HC_HCT4520_Q100 v.1
Modifications:	<ul style="list-style-type: none">The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.Legal texts have been adapted to the new company name where appropriate.Type number 74HC4520PW-Q100 (SOT403-1) removed.			
74HC_HCT4520_Q100 v.1	20141204	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <https://www.nexperia.com>.

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